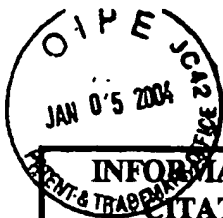


D.J.  
#2 9-15-01  
T.D.S.W. / [Signature]  
Page No. 1 of 1

| <b>INFORMATION DISCLOSURE<br/>CITATION FORM FOR<br/>PATENT APPLICATION<br/>(FORM PTO-1449)<br/>(Substitute)</b>   |                 |            | Docket No.: 460-010467-US(PAR)<br><br>Applicant(s): IJAS et al.<br><br>Filing Date: Herewith |                                 | Serial No.:<br><br>Group:  |             |
|---|-----------------|------------|--|---------------------------------|----------------------------|-------------|
| <b>U.S. PATENTS</b>   |                 |            |  |                                 |                            |             |
| Initials  | Patent Number   | Issue Date | Name   | Class                           | Sub-class                  | Filing date |
| mcu   | 6,047,196       | 4/4/00     | Makela et al.  | 455                             | 556                        | 5/29/96     |
| mcu   | 5,734,513       | 3/31/98    | Wang et al.  | 359                             | 742                        | 4/3/96      |
| mcu   | 6,069,648 *     | 5/30/00    | Suso et al.  | 348                             | 14                         | 8/14/98     |
| <b>FOREIGN PATENT DOCUMENTS</b>   |                 |            |  |                                 |                            |             |
| Initials  | Document Number | Date       | Country  | Name                            | Translation?<br>Yes/No/n/a |             |
| mcu   | EP 0963100 A1   | 12/8/99    | Europe   | Nokia Mobile Phones Ltd.        | n/a                        |             |
| mcu   | GB 2333005 *    | 7/7/99     | United Kingdom   | Siemens Aktiengesellschaft      | n/a                        |             |
| mcu   | 09-305259 *     | 11/28/97   | Japan  | Hitachi Ltd.                    | Yes                        |             |
| mcu   | DE 4204326      | 8/27/92    | Germany  | Reichert                        | No                         |             |
| <b>OTHER DOCUMENTS (Title, Author, Date, Pages, Etc., if known)</b>   |                 |            |  |                                 |                            |             |
|   |                 |            |  |                                 |                            |             |
|   |                 |            |  |                                 |                            |             |
|   |                 |            |  |                                 |                            |             |
|   |                 |            |  |                                 |                            |             |
|   |                 |            |  |                                 |                            |             |
|   |                 |            |  |                                 |                            |             |
|   |                 |            |  |                                 |                            |             |
| <b>Examiner's Signature:</b> [Signature]  |                 |            |  | <b>Date Considered:</b> 1/03/04 |                            |             |
| Initial if reference was considered, whether or not citation is in conformance with MPEP. Mark through citation if not considered.<br>Include a copy of this citation form with your next correspondence to the Applicant(s). |                 |            |  |                                 |                            |             |

**INFORMATION DISCLOSURE  
CITATION FORM FOR  
PATENT APPLICATION  
(FORM PTO-1449)  
(Substitute)**

Docket No.: 460-010467-US(PAR)

Serial No.: 09/918,283

Applicant(s): J. Ijas et al.

Filing Date: 7/30/01

Group: 2681

**U.S. PATENTS**

| Initials | Patent Number | Issue Date | Name           | Class | Sub-class | Filing date |
|----------|---------------|------------|----------------|-------|-----------|-------------|
| mcu      | 5,923,751     | 7/13/99    | Ohtsuka et al. | 379   | 433       | 11/1/95     |

**RECEIVED**

JAN 07 2004

Technology Center 2600

**U.S. PATENT PUBLICATIONS**

| Initials | Publication No. | Pub. Date | Name | Class | Sub-class | Filing Date |
|----------|-----------------|-----------|------|-------|-----------|-------------|
|          |                 |           |      |       |           |             |

**FOREIGN PATENT DOCUMENTS**

| Initials | Document Number | Date     | Country | Name                      | Translation?<br>Yes/No/n/a |
|----------|-----------------|----------|---------|---------------------------|----------------------------|
| mcu      | EP 0898405A2    | 24.02.99 | EPO     | Hitachi, Ltd.             | n/a                        |
| mcu      | GB 2314179A     | 17.12.97 | UK      | John Q. Phillipps         | n/a                        |
| mcu      | EP 0898223A2    | 24.02.99 | EPO     | Lucent Technologies, Inc. | n/a                        |

**OTHER DOCUMENTS (Title, Author, Date, Pages, Etc., if known)**

|  |  |
|--|--|
|  |  |
|  |  |
|  |  |
|  |  |
|  |  |
|  |  |
|  |  |

Examiner's Signature:

Date Considered: 1/4/04

Initial if reference was considered, whether or not citation is in conformance with MPEP. Mark through citation if not considered.  
Include a copy of this citation form with your next correspondence to the Applicant(s).